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**Product data sheet** 

## 1. Product profile

### 1.1 General description

The BB175 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package.

### 1.2 Features and benefits

- High linearity
- Ultra small SMD plastic package
- $C_{d(28V)} = 2.7 \text{ pF}$ ;  $C_{d(1V)}$  to  $C_{d(28V)}$  ratio = 22
- Low series resistance

### 1.3 Applications

■ Voltage Controlled Oscillators (VCO)

## 2. Pinning information

Table '	1.	<b>Pinning</b>
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Pin	Description	Simplified outline	Symbol
1	cathode	[1]	Ш
2	anode	1 2	sym008

<sup>[1]</sup> The marking bar indicates the cathode.

# 3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB175	SC-79	plastic surface-mounted package; 2 leads	SOD523



### VHF variable capacitance diode

# 4. Marking

Table 3. Marking

Type number	Marking code
BB175	CH

# 5. Limiting values

### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{R}$	reverse voltage		-	32	V
		peak value in series with a 10 $k\Omega$ resistor	-	35	V
l <sub>F</sub>	forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

## 6. Characteristics

Table 5. Characteristics

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>R</sub>	reverse current	$V_R = 30 V$	[1]	-	-	10	nΑ
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nΑ
r <sub>s</sub>	diode series resistance	$f = 100 \text{ MHz}; C_d = 30 \text{ pF}$		-	1.0	1.2	Ω
$C_d$	diode capacitance	f = 1 MHz	[2]				
		V <sub>R</sub> = 1 V		52	-	62	pF
		V <sub>R</sub> = 28 V		2.48	2.7	2.89	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz		-	1.31	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		20.6	22	-	
C <sub>d(25V)</sub> /C <sub>d(28V)</sub>	diode capacitance ratio (25 V to 28 V)	f = 1 MHz		-	1.05	-	

<sup>[1]</sup> See Figure 2.

<sup>[2]</sup> See Figure 1 and Figure 3.

### VHF variable capacitance diode

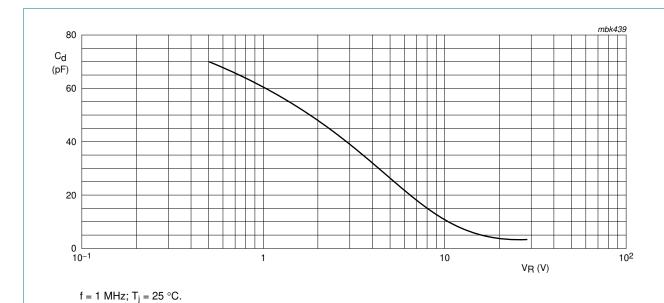


Fig 1. Diode capacitance as a function of reverse voltage; typical values.

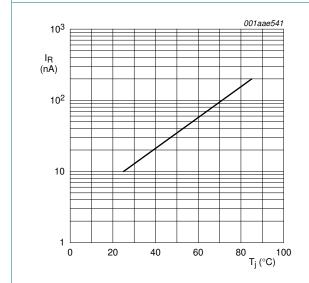


Fig 2. Reverse current as a function of junction temperature; maximum values.

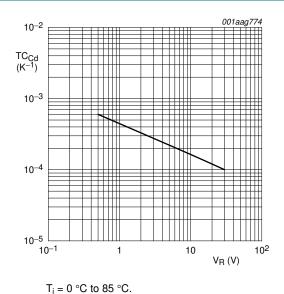


Fig 3. Diode capacitance temperature coefficient as a function of reverse voltage; typical values.

### VHF variable capacitance diode

# Package outline

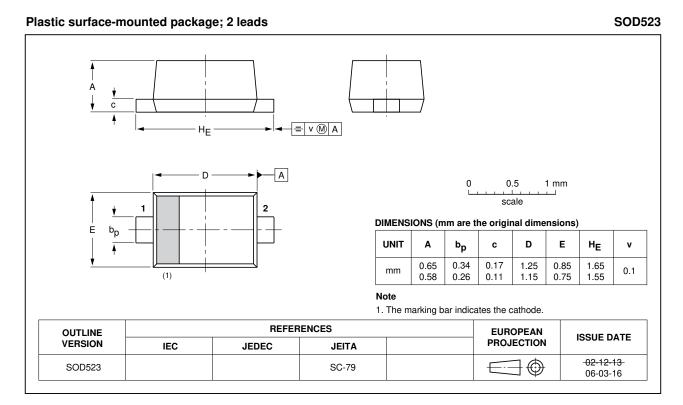


Fig 4. Package outline SOD523 (SC-79)

VHF variable capacitance diode

# 8. Abbreviations

### Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

# 9. Revision history

### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB175 v.1	20130325	Product data sheet	-	-

#### VHF variable capacitance diode

## 10. Legal information

#### 10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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BB175

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#### VHF variable capacitance diode

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